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# **BLP7G22-05**

# **LDMOS** driver transistor

Rev. 3 — 1 September 2015

AMPLEON Product data sheet

### 1. Product profile

#### 1.1 General description

A 5 W plastic LDMOS power transistor for base station applications from 700 MHz to 2700 MHz band.

Table 1. Application information

Typical RF performance at  $T_{case} = 25$  °C; in a class-AB application circuit.

Test signal	f	I <sub>Dq</sub>	V <sub>DS</sub>	P <sub>L(AV)</sub>	Gp	η <sub>D</sub>	ACPR
	(MHz)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
IS-95 [1]	788	60	28	1	23.9	25	<del>-4</del> 1
2-carrier W-CDMA 2	2140	55	28	1	16.7	27	-40
Pulsed CW	2700	55	28	5	14.5	45	-

<sup>[1]</sup> Single carrier IS-95 with pilot, paging, sync and 6 traffic channels (Walsh codes 8 - 13). PAR = 9.7 dB at 0.01 % probability on the CCDF. Channel bandwidth is 1.2288 MHz.

#### 1.2 Features and benefits

- High efficiency
- Excellent ruggedness
- Designed for broadband operation
- Excellent thermal stability
- High power gain
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

#### 1.3 Applications

- CDMA
- W-CDMA
- GSM EDGE
- MC-GSM
- LTE
- WiMAX

<sup>[2]</sup> Test signal: 2-carrier W-CDMA: carrier spacing = 5 MHz. PAR = 8.4 dB at 0.01% probability on CCDF; RF performance at  $V_{DS}$  = 28 V;  $I_{Dg}$  = 55 mA.

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# 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1, 4, 5, 6, 7, 8, 9, 12	n.c.		40.44
2, 3	gate		10, 11 —
10, 11	drain		2, 3
13	source [1]		13
		<u> </u>	aaa-007870
		Transparent top view	

<sup>[1]</sup> Connected to flange.

# 3. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
BLP7G22-05	HVSON12	plastic thermal enhanced very thin small outline package; no leads; 12 terminals; body $6\times4\times0.85$ mm	SOT1179-2	

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
$V_{GS}$	gate-source voltage		-0.5	+13	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C

### 5. Recommended operating conditions

See application note AN11198 for more details.

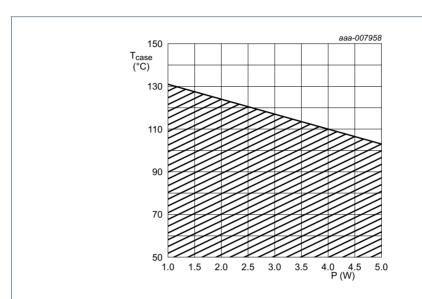


Fig 1. Recommended operating area; case temperature as a function of power dissipation

#### 6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ Unit
$R_{\text{th(j-c)}}$	thermal resistance from junction to case	$T_{case}$ = 80 °C; $P_L$ = 5 W	[1] 6.4 K/W

<sup>[1]</sup> R<sub>th(j-c)</sub> is measured under RF conditions.

#### 7. Characteristics

Table 6. DC characteristics

 $T_i$  = 25 °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.09 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS}$ = 10 V; $I_{D}$ = 9 mA	1.5	1.9	2.3	V
$V_{GSq}$	gate-source quiescent voltage	$V_{DS}$ = 28 V; $I_{D}$ = 55 mA	1.45	2.0	2.55	V
I <sub>DSS</sub>	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	1.4	μА
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	1.6	-	Α
I <sub>GSS</sub>	gate leakage current	$V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	140	nA
9fs	forward transconductance	$V_{DS} = 10 \text{ V}; I_{D} = 9 \text{ mA}$	-	80	-	mS
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 315 \text{ mA}$	-	2	-	Ω

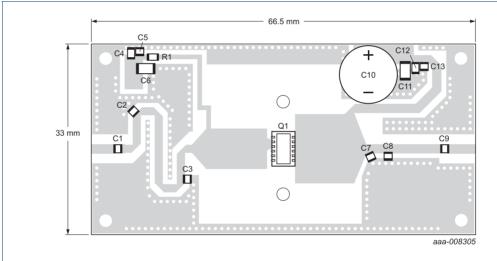
Table 7. RF characteristics

Test signal: 1-tone pulsed;  $t_p$  = 50  $\mu$ s;  $\delta$  = 10 %; f = 2140 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 55 mA;  $T_{case}$  = 25  $^{\circ}$ C; unless otherwise specified, in a production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	$P_{L(AV)} = 1 W$	15	16	-	dB
$\eta_{D}$	drain efficiency	$P_{L(AV)} = 1 W$	20	23	-	%
P <sub>L(1dB)</sub>	output power at 1 dB gain compression		5.5	-	-	W
RLin	input return loss	$P_{L(AV)} = 1 W$	-	-16	-12	dB

### 8. Application information

### 8.1 Application circuit



Printed-Circuit Board (PCB): Rogers RO4350;  $\epsilon_{\text{r}}$  = 3.48; thickness = 0.762 mm; thickness copper plating = 35  $\mu m$ .

See Table 8 for list of components.

Fig 2. Component layout

**Table 8.** List of components
See Figure 2 for component layout.

	•		
Component	Description	Value	Remarks
C1, C9	multilayer ceramic chip capacitor	15 pF	[1]
C2	multilayer ceramic chip capacitor	1.8 pF	[1]
C3	multilayer ceramic chip capacitor	1.6 pF	[1]
C4, C12	multilayer ceramic chip capacitor	100 nF, 50 V	[2]
C5, C13	multilayer ceramic chip capacitor	10 pF	[1]
C6, C11	multilayer ceramic chip capacitor	1 μF, 50 V	[2]
C7	multilayer ceramic chip capacitor	3.0 pF	[1]
C8	multilayer ceramic chip capacitor	1.6 pF	[1]

Table 8. List of components ...continued

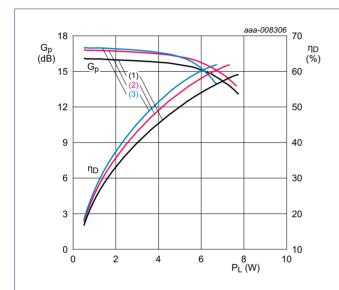
See Figure 2 for component layout.

Component	Description	Value	Remarks
C10	electrolytic capacitor	$220~\mu F,63~V$	
R1	chip resistor	4.7 Ω	SMD 0805
Q1	transistor	-	BLP7G22-05

- [1] American Technical Ceramics type 100A or capacitor of same quality.
- [2] Murata GRM32RR71H05KA01L or capacitor of same quality.

#### 8.2 Graphical data

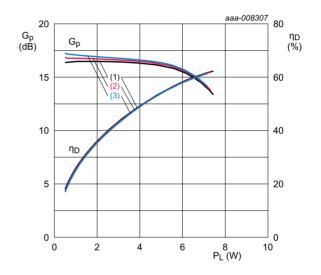
#### 8.2.1 Pulsed CW



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 50 mA;  $T_{case}$  = 25 °C;  $\delta$  = 10 %;  $t_{p}$  = 20  $\mu s$  .

- (1) f = 2110 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 3. Power gain and drain efficiency as function of output power; typical values

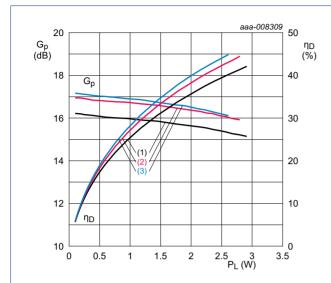


 $V_{DS}$  = 28 V; f = 2140 MHz;  $T_{case}$  = 25 °C;  $\delta$  = 10 %;  $t_{p}$  = 20  $\mu s$ .

- (1)  $I_{Dq} = 40 \text{ mA}$
- (2)  $I_{Dq} = 50 \text{ mA}$
- (3)  $I_{Dq} = 60 \text{ mA}$

Fig 4. Power gain and drain efficiency as function of output power; typical values

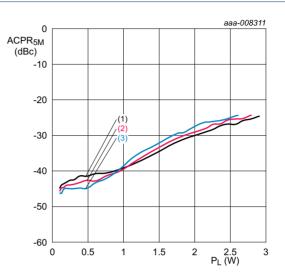
#### 8.2.2 2-Carrier W-CDMA



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 50 mA;  $T_{case}$  = 25 °C; carrier spacing = 5 MHz; 46 % clipping; PAR = 8.4 dB at 0.01 % probability on CCDF.

- (1) f = 2110 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 5. Power gain and drain efficiency as function of output power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 50 mA;  $T_{case}$  = 25 °C; carrier spacing = 5 MHz; 46 % clipping; PAR = 8.4 dB at 0.01 % probability on CCDF.

- (1) f = 2110 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 6. Adjacent channel power ratio (5 MHz) as a function of output power; typical values

#### 9. Test information

#### 9.1 Ruggedness in class-AB operation

The BLP7G22-05 is capable of withstanding a load mismatch corresponding to VSWR = 10: 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Dq}$  = 55 mA;  $P_L$  = 5 W (CW).

## 10. Package outline

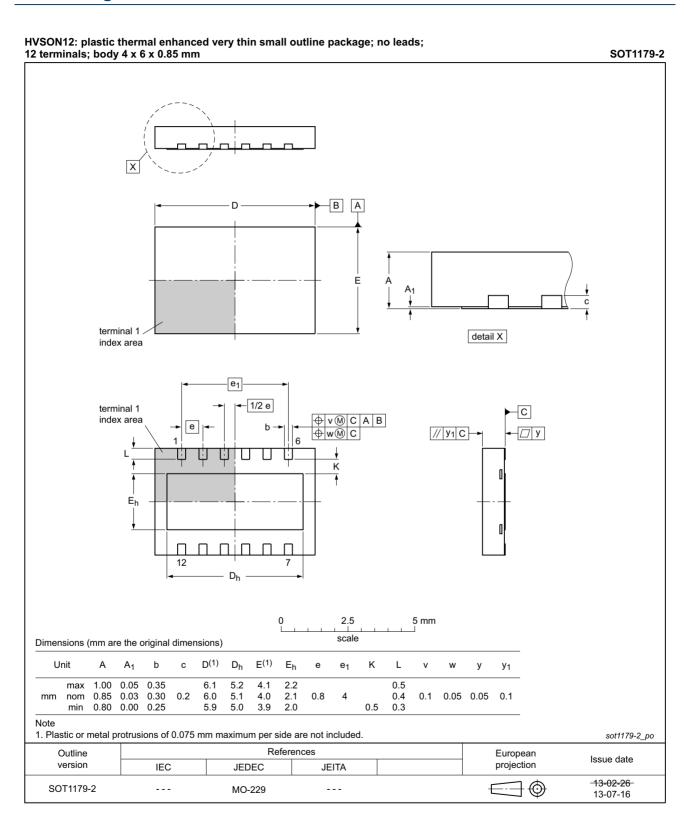


Fig 7. Package outline SOT1179-2 (HVSON12)

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# 11. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

## 12. Abbreviations

Table 9. Abbreviations

14510 0. /	abbiovidiono
Acronym	Description
CCDF	Complementary Cumulative Distribution Function
CDMA	Code Division Multiple Access
CW	Continuous Wave
EDGE	Enhanced Data rates for GSM Evolution
ESD	ElectroStatic Discharge
GSM	Global System for Mobile Communication
IS-95	Interim Standard 95
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LTE	Long Term Evolution
MC-GSM	Multi Carrier GSM
PAR	Peak-to-Average Ratio
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio
W-CDMA	Wideband Code Division Multiple Access
WiMAX	Worldwide Interoperability for Microwave Access

# 13. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLP7G22-05#3	20150901	Product data sheet		BLP7G22-05 v.2	
Modifications:	guidelines of Am	The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.			
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
BLP7G22-05 v.2	20130820	Product data sheet	-	BLP7G22-05 v.1	
BLP7G22-05 v.1	20130528	Objective data sheet	-	-	

**LDMOS** driver transistor

### 14. Legal information

#### 14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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